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Vishay/Siliconix SIR640DP-T1-GE3

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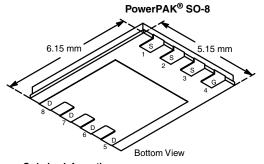




Vishay Siliconix

N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)		
40	0.0017 at V _{GS} = 10 V	60	34.6 nC		
	0.0022 at V _{GS} = 4.5 V	60	34.0110		



Ordering Information: SiR640DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

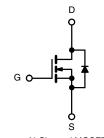
FEATURES

- TrenchFET® Power MOSFET
- Low Q_g for High Efficiency
- 100 % R_g and UIS Tested
 - Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

COMPLIANT HALOGEN

APPLICATIONS

- Synchronous Rectification
- DC/DC Converter



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		60 ^a		
Continuous Dunin Comment (T. 150 °C)	T _C = 70 °C		60 ^a		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	45 ^{b, c}		
	T _A = 70 °C		36 ^{b, c}		
Pulsed Drain Current (t = 100 μs)		I _{DM}	350	Α	
Continuous Courses Prain Diada Current	T _C = 25 °C		60 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	5.6 ^{b, c}	7	
Single Pulse Avalanche Current	1 0.1 ml l	I _{AS}	40		
Single Pulse Avalanche Energy L = 0.1 mH		E _{AS}	80	mJ	
	T _C = 25 °C		104		
Maximum Power Dissipation	T _C = 70 °C		66.6	w	
	T _A = 25 °C	P _D	6.25 ^{b, c}		
	T _A = 70 °C		4 ^{b, c}		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature	-	260			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	15	20	°C/W		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	0.9	1.2	C/VV		

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- d. See solder profile (www.vishav.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- Maximum under steady state conditions is 54 °C/W.

Document Number: 67190

For technical questions, contact: pmostechsupport@vishay.com

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S13-0830-Rev. B, 22-Apr-13

This document is subject to change without notice.

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Datasheet of SIR640DP-T1-GE3 - MOSFET N-CH 40V 60A PPAK SO-8

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SiR640DP

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						l	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40			V	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.3		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2.3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V			1		
		V _{DS} = 40 V, V _{GS} = 0 V, T _J = 55 °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
Drain-Source On-State Resistance ^a	D	V _{GS} = 10 V, I _D = 20 A		0.0014	0.0017		
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0018	0.0022	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		110		S	
Dynamic ^b				•			
Input Capacitance	C _{iss}			4930		pF	
Output Capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		3810			
Reverse Transfer Capacitance	C _{rss}			314			
Table Oats Observe	Q _g	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		75	113	nC	
Total Gate Charge		V _{DS} = 20 V, V _{GS} = 4.5 V, I _D = 20 A		34.6	52		
Gate-Source Charge	Q _{gs}			11			
Gate-Drain Charge	Q _{gd}			8.2			
Gate Resistance	R_g	f = 1 MHz	0.4	1.3	2.6	Ω	
Turn-On Delay Time	t _{d(on)}			19	35		
Rise Time	t _r	$V_{DD} = 20 \text{ V}, R_L = 2 \Omega$		11	20	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		50	90		
Fall Time	t _f			10	20		
Turn-On Delay Time	t _{d(on)}			46	90		
Rise Time	t _r	$V_{DD} = 20 \text{ V}, R_L = 2 \Omega$		88	170		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		56	110		
Fall Time	t _f			25	50		
Drain-Source Body Diode Characteristic	S				L		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			60		
Pulse Diode Forward Current (t = 100 μs)	I _{SM}				350	A	
Body Diode Voltage	V _{SD}	I _S = 5 A		0.69	1.1	٧	
Body Diode Reverse Recovery Time	t _{rr}			83	160	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 10 A, dl/dt = 100 A/μs, T _J = 25 °C		77	150	nC	
Reverse Recovery Fall Time	t _a			26		ns	
Reverse Recovery Rise Time	t _b			57			

Notes

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

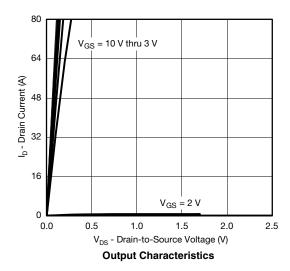


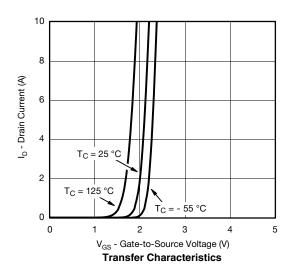


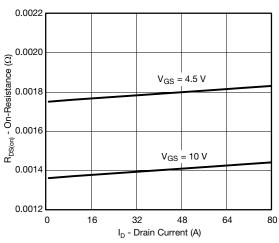
SiR640DP

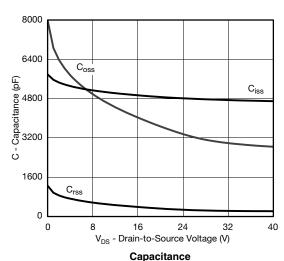
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

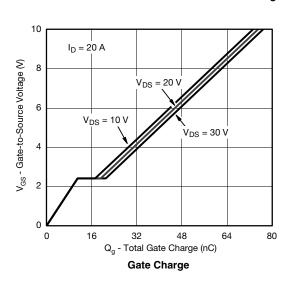


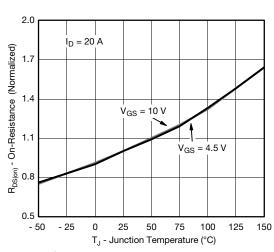






On-Resistance vs. Drain Current and Gate Voltage





On-Resistance vs. Junction Temperature

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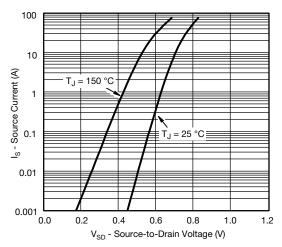


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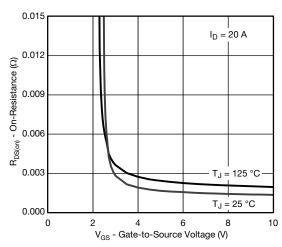
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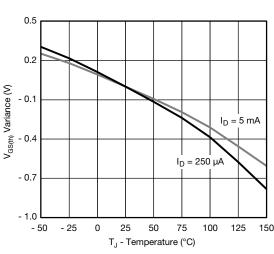




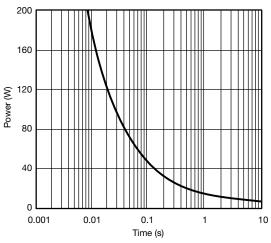
Source-Drain Diode Forward Voltage



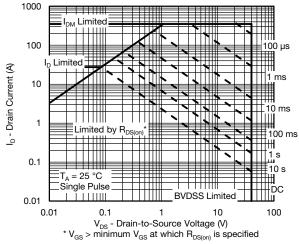
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

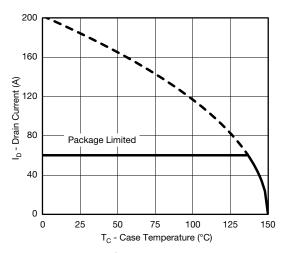




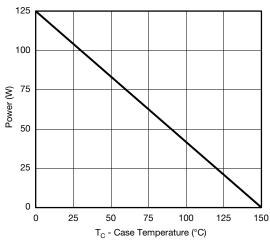
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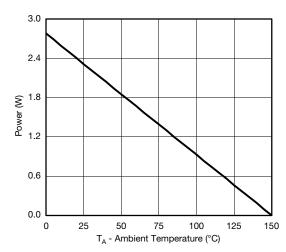
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*







Power, Junction-to-Ambient

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^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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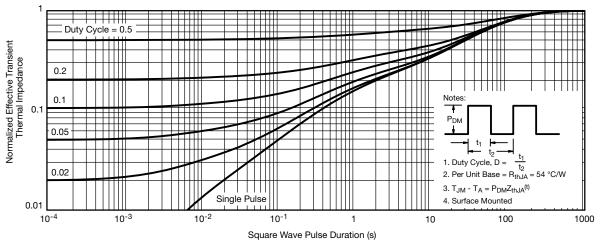
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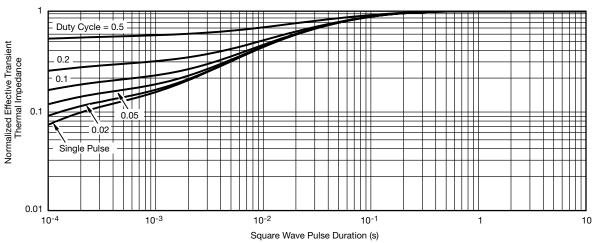
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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